



SPECIFICATIONS

CUSTOMER	:	SCHUKAT
MASS PRODUCTION CODE	:	SMMH050800480H-C22
SAMPLE VERSION	:	01
SPECIFICATIONS EDITION	:	001
DRAWING NO. (Ver.)	:	SMMH050800480H-C22-WX-A

Customer Approved

Date:

Approved	Checked	Designer
	闫伟	朱海

- ☐ Preliminary specification for design input
- ☒ Specification for sample approval

[illegible]

SAMPLE Ver.02
SPEC Edi.003



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Note : For detailed information please refer to IC data sheet :

Primacy(TFT LCD):ST72568-G6-L



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	800*480
LCD Type	Normally black, Transmissive type
Screen size(inch)	5 inch
Viewing Direction	FREE
Other(controller/driver IC)	ST72568-G6-L
Interface	RGB

1.2 Mechanical Specifications

Module

Item	Standard Value	Unit
Outline Dimension	132.2(W) ×89.0(H) ×4.85(D) mm	mm

TFT LCD

Item	Standard Value	Unit
Active Area	108(H)×64.8(V)	mm



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
Operating Temperature	T _{OP}	-	-30	80	°C
Storage Temperature	T _{ST}	-	-30	80	°C

1.4 DC Electrical Characteristics

Module

GND = 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Digital Supply Voltage	VDD	-	3.1	3.3	3.6	V
Input H/L Level Voltage	VIH	-	0.7VDD	-	VDD	V
	VIL	-	GND	-	0.3VDD	V
Output H/L Level Voltage	VOH	-	VDD-0.4	-	VDD	V
	VOL	-	GND	-	GND+0.4	V
Supply Current	IDD	-	-	70	100	mA



1.5 Optical Characteristics

TFT LCD Module

VDD= 3.3 V, Ta=25°C

Item		Symbol	Condition	Min.	Typ.	Max.	unit	-	
Response time	Tr+Tf	25℃	-	-	30	40	ms	-	
Viewing angle	Top	θY+	CR ≥ 10	70	80	-	Deg.	Note 4	
	Bottom	θY-		70	80	-			
	Left	θX-		70	80	-			
	Right	θX+		70	80	-			
Contrast ratio		CR	IF=120mA	700	1000	-	-	Note 3	
Color of CIE Coordinate (B/L & LCD&CTP)	White	X		-0.05	0.310	+0.05	-	Note1	
		Y			0.350				
	Red	X			0.610				
		Y			0.370				
	Green	X			0.330				
		Y			0.611				
	Blue	X			0.170				
		Y			0.110				
Average Brightness Pattern=white display (B/L & LCD&CTP)		IV		IF=120mA	800	1000	-	cd/m2	Note1
Uniformity (B/L & LCD&CTP)		△B		IF=120mA	75	-	-	%	Note1

Note 1:

*1 : $\Delta B = B(\min) / B(\max) * 100\%$

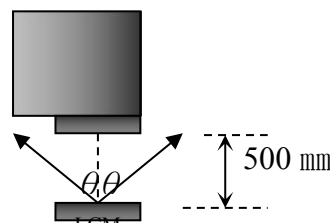
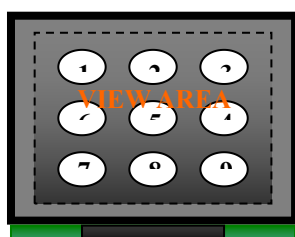
*2 : Measurement Condition for Optical Characteristics:

a : Environment: $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ / $60 \pm 20\%$ R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: 500 ± 50 mm , ($\theta = 0^{\circ}$)

c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.

d : The uncertainty of the C.I.E coordinate measurement ± 0.01 , Average Brightness $\pm 4\%$



Colorimeter=BM-7



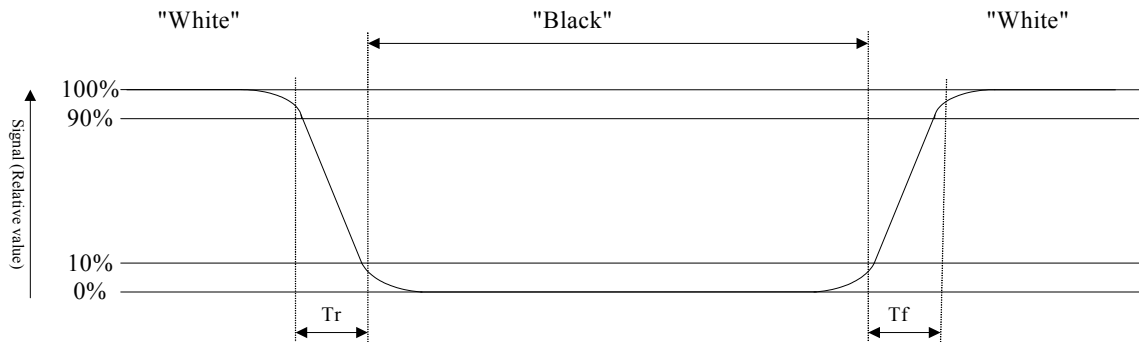
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

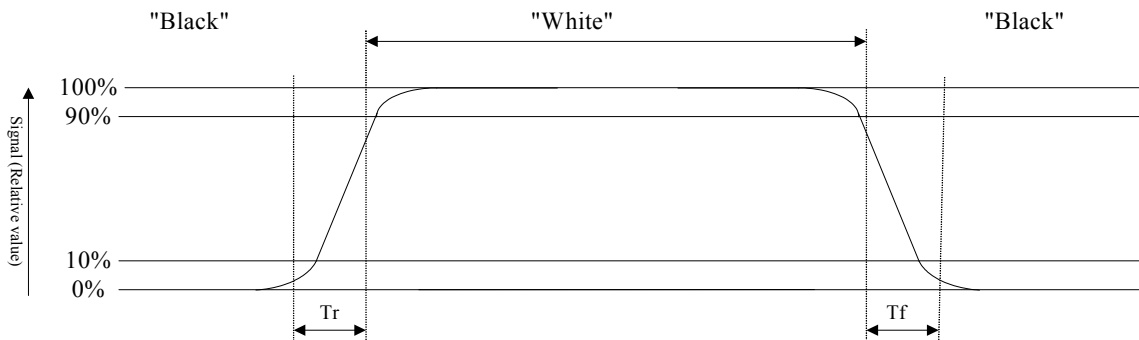
The output signals of photo detector are measured when the input signals are changed from “black” to “white”(falling time) and from “white” to “black”(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:

Normally White



Normally Black



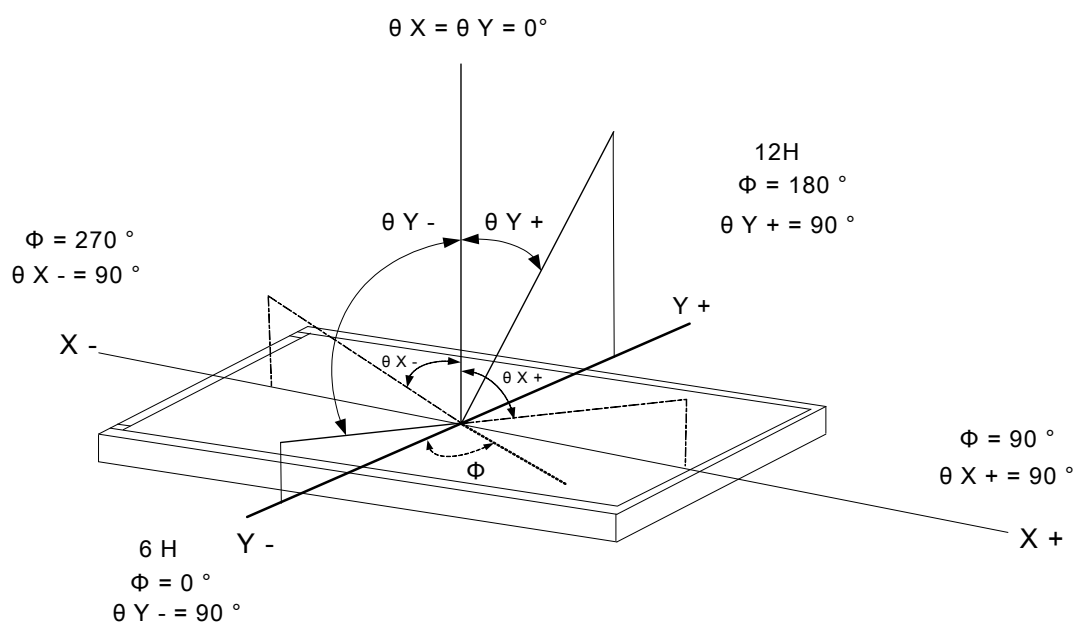
Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at "White" state}}{\text{Photo detector output when LCD is at "Black" state}}$$

Note4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

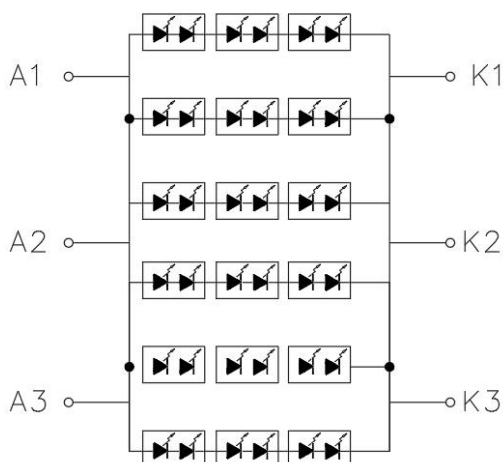
1.6.1 Backlight LED Driver IC (MP3362) Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
Led Driver Power Voltage	VLED	3.0	3.3	12	V
Led Driver Power Current	ILED	-	0.82	-	A
PWM Dimming Freq	FDIM	-	-	2	KHZ
EN threshold	EN ON	1.3	-	-	V
	EN OFF	-	-	0.4	V

1.6.2 Internal Backlight Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF=120mA	16.8	18	19.2	V
Average Brightness	IV		19000	24000	-	cd/m²
CIE Color Coordinate	X		0.28	0.30	0.32	-
	Y		0.29	0.31	0.33	
Led lifetime				50k		
Color	White					

Circuit Diagram





1.7 CTP Characteristics

Items.	Specification	Remark
Touch Panel Size	5 Inch	
Touch type	True Multi-touch with up to 5 Points of Absolution X and Y coordinates	
Input Method	VDD	
Structure type	G+G	
Interface	I ² C	
I2C address	0x55	
Operation Temperature	-30~80℃	
Storage Temperature	-30~80℃	
Control IC	ST1633i	
Transparency	≥86%	
Structure	Glass : T =1.1mm	
	Sensor: T =0.55mm	



1.8 EEPROM Information

1.8.1 EEPROM Number :M24C02-RMN6TP

1.8.2 EEPROM Device Address 7bit :0X50

1.8.3 EEPROM Register Information:

Address	Description	Data	Name/Value(typ)	Notes
00h	No Data	00h	0	
01h	TFP-Interface	01h	DPI	1: DPI, 2: DSI
02h	CTP-Interface	01h	I2C	0: No CTP, 1: I2C
03h	Manufacturer	53h	S	SM: Smartwin (ASCII)
04h		57h	M	
05h		00h		
06h	Size	05h	5 inch	xx.xx inch
07h		00h		
08h	X-Res.(H-Byte)	03h	800 px	
09h	X-Res.(L-Byte)	20h		
0Ah	Y-Res.(H-Byte)	01h	480px	
0Bh	Y-Res.(L-Byte)	E0h		
0Ch	Pixel-Clock(typ.)	19h	25 MHz	xx.xx MHz
0Dh		00h		
0Eh	Color-Depth	18h	24 bit	
0Fh	HBP(H-Byte)	00h	8	
10h	HBP(L-Byte)	08h		
11h	HPW	04h	4	
12h	HFP(H-Byte)	00h	8	
13h	HFP(L-Byte)	08h		
14h	VBP(H-Byte)	00h	16	
15h	VBP(L-Byte)	10h		
16h	VPW	04h	4	
17h	VFP(H-Byte)	00h	16	
18h	VFP(L-Byte)	10h		
19h	Polarity_Mode	24h	00100100b	Bit0: H_sync_polarity Bit1: V_sync_polarity Bit2: DE_polarity (0: Negative, 1: Positive) Bit3: H_sync_phase(Reserve) Bit4: V_sync_phase(Reserve) Bit5: DE_phase (0: Rising edge, 1: Falling edge) Bit6: Pixel_invert Bit7: DE_mode (0: DE enabled,1: Combined Sync)
1Ah	Rotation	00h	00000000b	Bit 0: Display Mirror X Bit 1: Display Mirror Y Bit 2: Display Swap X/Y Bit 3: Reserved, 0 Bit 4: Touch Mirror X Bit 5: Touch Mirror Y Bit 6: Touch Swap X/Y Bit 7: Reserved, 0
1Bh	Reserve	00h	0	
1Ch-FFh	No Data	00h	0	



2. MODULE STRUCTURE

2.1 Interface Pin Description Interface of TFT

Pin No.	Symbol	Description
1	GND	Ground
2	GND	Ground
3	GND	Ground
4	GND	Ground
5	+3V3 BKL	3.3V Power Input for BKL
6	+3V3 BKL	3.3V Power Input for BKL
7	+3V3 BKL	3.3V Power Input for BKL
8	+3V3 BKL	3.3V Power Input for BKL
9	PWM BKL	Back light PWM Control signal
10	+3V3 TFT	3.3V Power Input for TFT
11	GND	Ground
12	R0	Red data signal
13	R1	Red data signal
14	R2	Red data signal
15	R3	Red data signal
16	R4	Red data signal
17	R5	Red data signal
18	R6	Red data signal
19	R7	Red data signal
20	G0	Green data signal



21	G1	Green data signal
22	G2	Green data signal
23	G3	Green data signal
24	G4	Green data signal
25	G5	Green data signal
26	G6	Green data signal
27	G7	Green data signal
28	B0	Blue data signal
29	B1	Blue data signal
30	B2	Blue data signal
31	B3	Blue data signal
32	B4	Blue data signal
33	B5	Blue data signal
34	B6	Blue data signal
35	B7	Blue data signal
36	GND	Ground
37	VSYNC	Vertical Sync input for TTL mode
38	HSYNC	Horizontal Sync input for TTL mode.
39	DE	Data input enable applied to the RGB interface.
40	GND	Ground

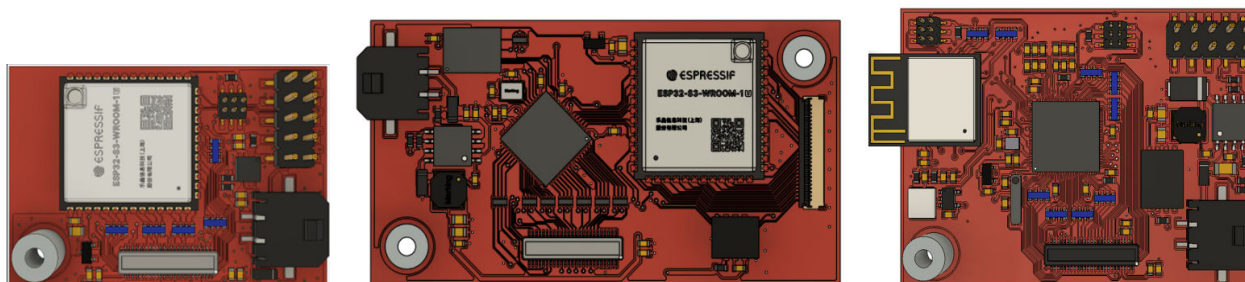


41	PCLK	Clock signal for data latching and internal
42	GND	Ground
43	MODE(STDYB)	Standby mode, Normally pull high.
44	TFT_RESET	TFT Reset Pin
45	TP-RST	CTP Reset Pin
46	TP-INT	INT Output
47	TP-SDA/EEPROM-SDA	TP I2C Data/EEPROM I2C Data
48	TP-SCL/EEPROM-SCL	TP I2C Clock/EEPROM I2C Clock
49	+3V3 CTP	3.3V Power Input for CTP
50	GND	Ground

Recommended matched connector :DF23C-50DP-0.5V

Recommended driving boards:

- ESoPe :SLD_C_W_S3
- ESoPe :SLD_C_W_S3_BT817
- ESoPe :SLD_C_W_P4_C6





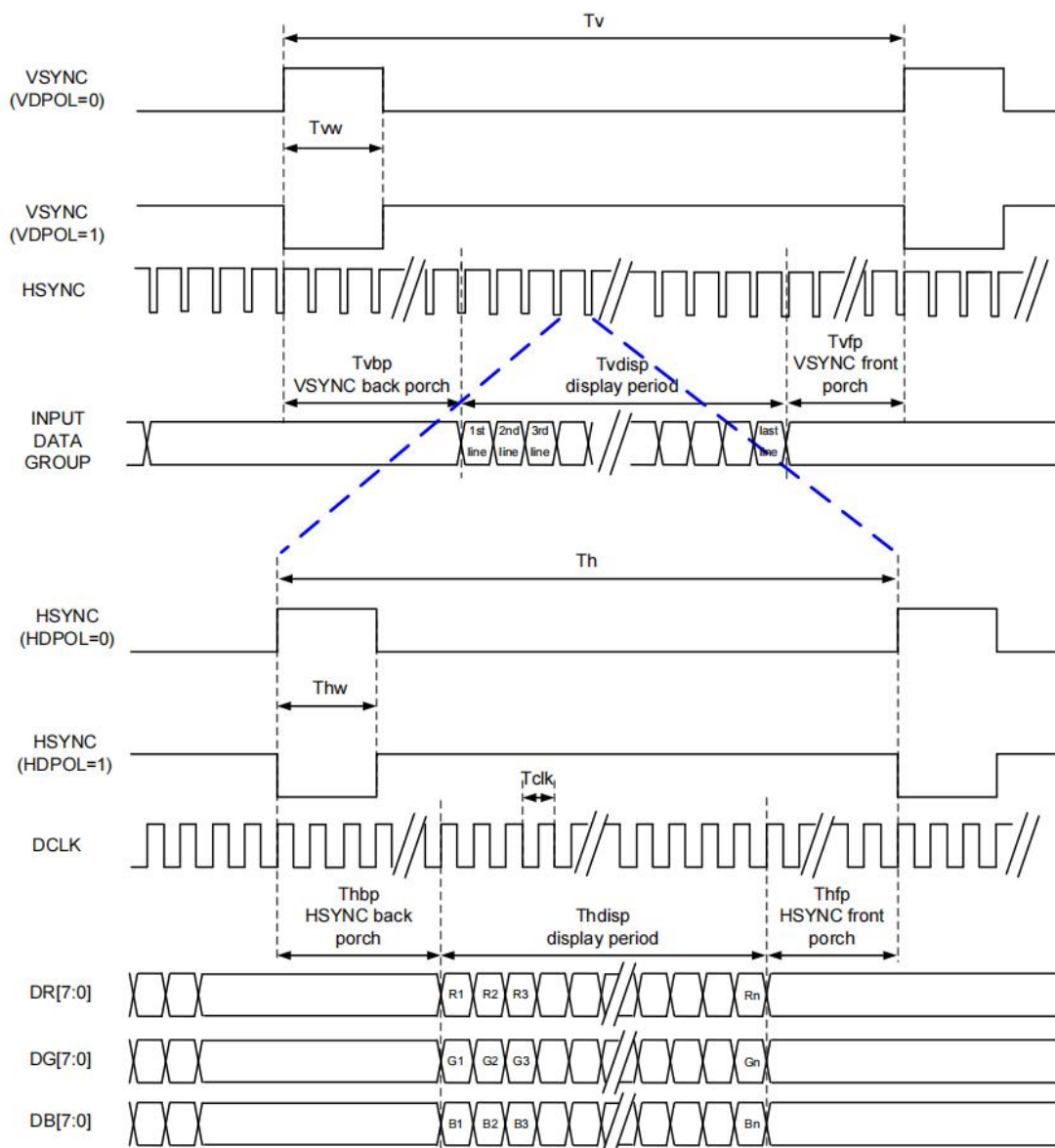
2.2 Timing Characteristics

2.2.1 RGB Interface

RGB Mode Selection Table	DCLK	HSYNC	VSYNC	DE
SYNC - DE Mode	Input	Input	Input	Input
SYNC Mode	Input	Input	Input	GND
DE Mode	Input	GND	GND	Input

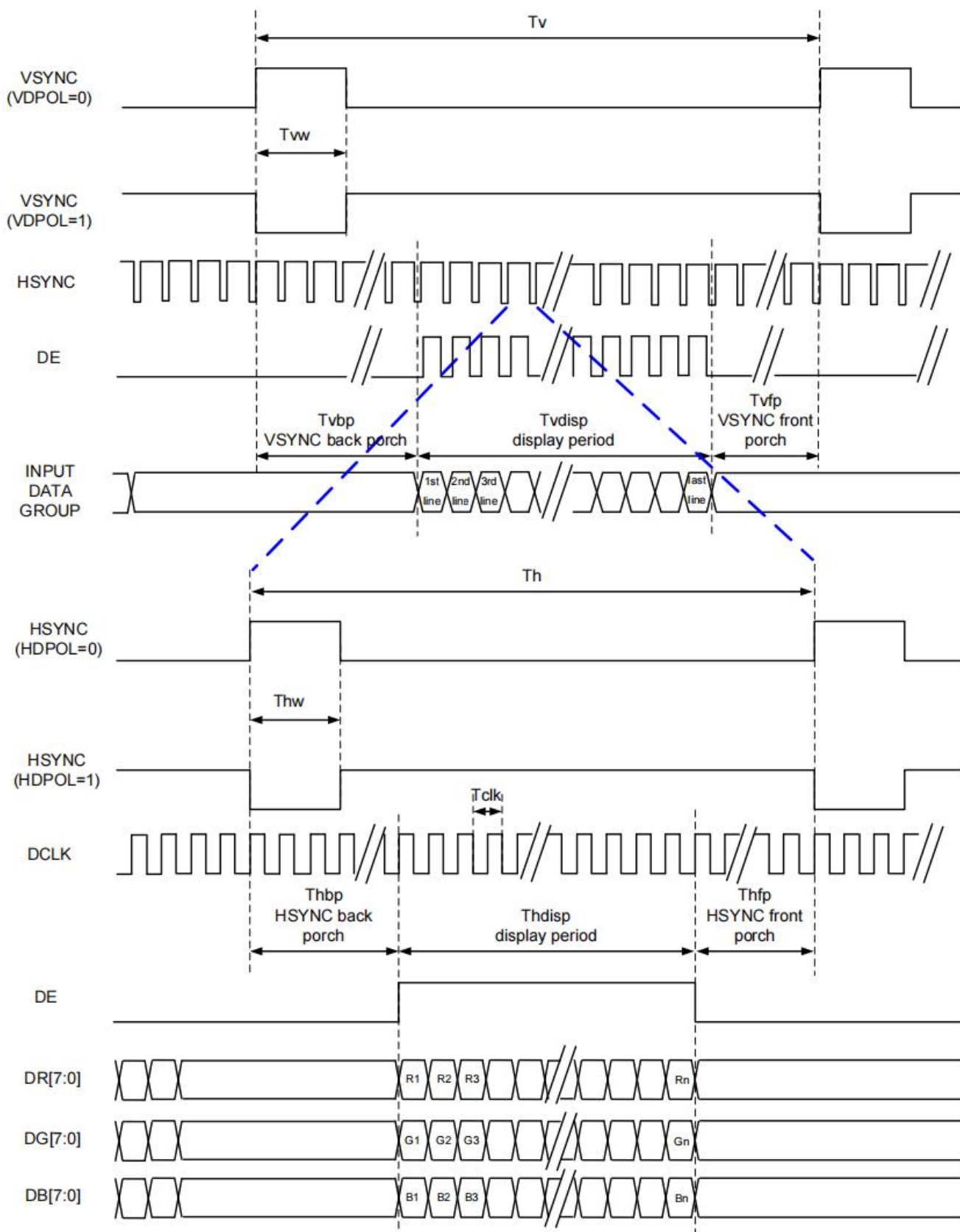
Note: "Input" means these signals are driven by host side

2.2.2 SYNC Mode



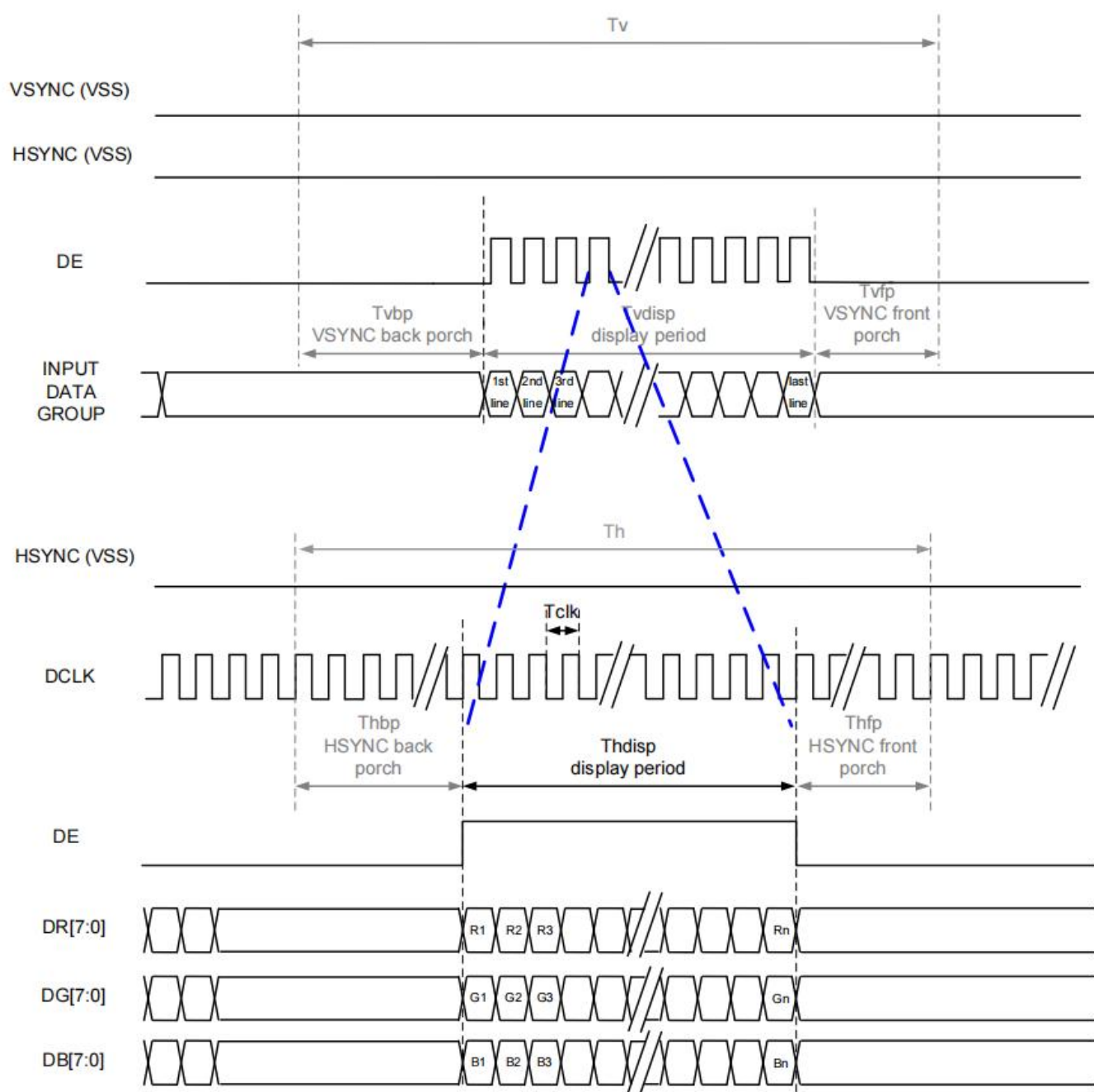


2.2.3 SYNC-DE Mode





2.2.4 DE Mode





2.2.5 Parallel 24-bit RGB Input Timing Table

Parallel 24-bit RGB Input Timing (PVDD=VDD=VDDI= 3.3V, AGND= 0V, TA=25°C)

Parallel 24-bit RGB Interface Timing Table						
Item	Symbol	Min.	Typ.	Max.	Unit	Remark
DCLK Frequency	Fclk	23	25	27	MHz	
HSYNC	Period Time	Th	808	816	848	DCLK
	Display Period	Thdisp	800		DCLK	
	Back Porch	Thbp	4	8	24	DCLK
	Front Porch	Thfp	4	8	24	DCLK
	Pulse Width	Thw	2	4	8	DCLK
VSYNC	Period Time	Tv	496	512	528	HSYNC
	Display Period	Tvdisp	480		HSYNC	
	Back Porch	Tvbp	8	16	24	HSYNC
	Front Porch	Tvfp	8	16	24	HSYNC
	Pulse Width	Tww	2	4	8	HSYNC

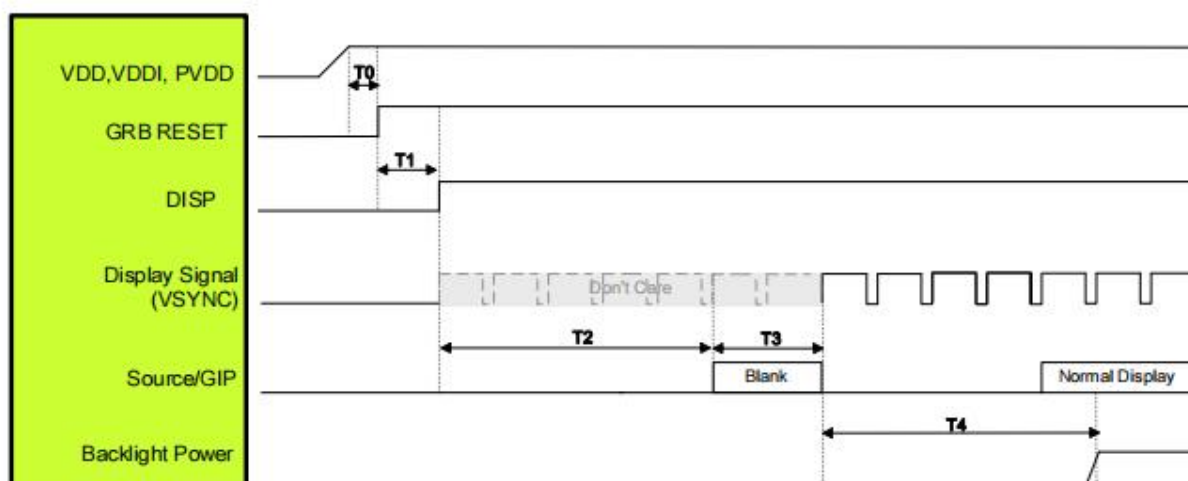
Note: 1. The minimum blanking time depends on the GIP timing of the panel specification

2. To ensure the compatibility of different panels, it is recommended to use the typical setting.

3. It is necessary to keep Tvbp =16 and Thbp =8 in sync mode. DE mode is unnecessary to keep it.



2.2.6 Power On Sequence



Symbol	Description	Time	Unit
T0	System power stability to GRB RESET signal	≥ 1	ms
T1	GRB RESET= "High" to DISP="High"	≥ 10	ms
T2	DISP="High" to Source/GIP scan blank	85	ms
T3	IC scan blanking signal	≥ 33	ms
T4	Display signal input to Backlight power on (base on Display Signal Frame Rate 60Hz)	≥ 100	ms

Note: 1. When DISP pull "H" or "L", IC will execute the internal power on or power off procedures. Please be careful about the timing of

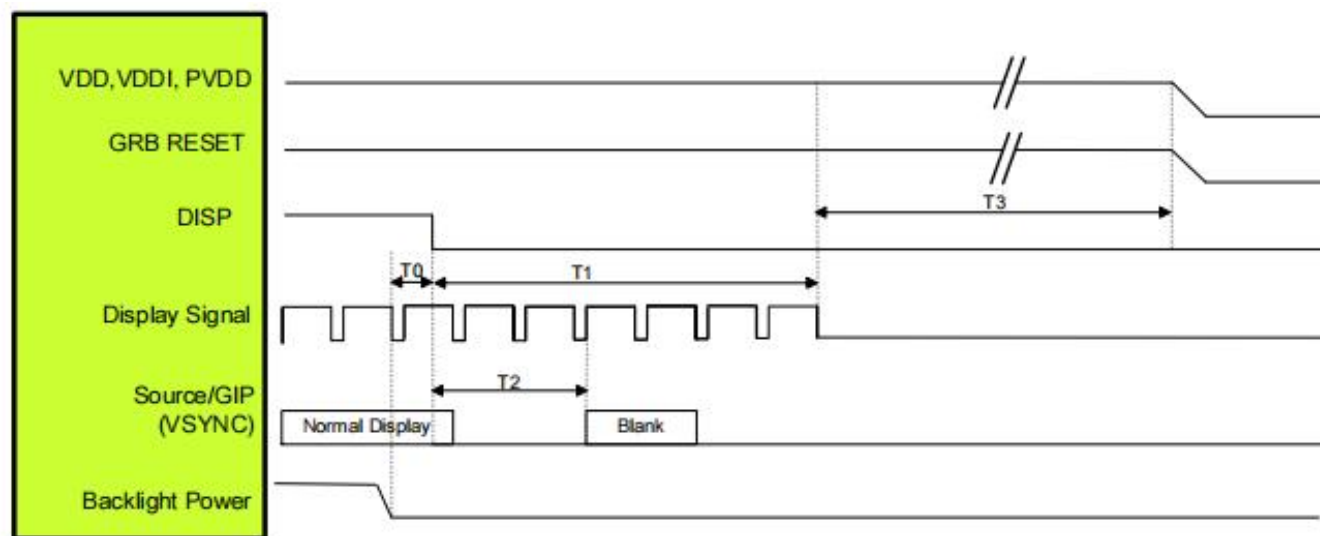
DISP and do not interrupt it during power on or power off procedure, otherwise unexpected errors will occur.

2. RGB interface Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0].

3. LVDS interface Display signal: DCLK P/N; RX[3:0] P/N



2.2.7 Power Off Sequence



Symbol	Description	Time	Unit
T0	Backlight Power off to DISP="Low"	≥1	ms
T1	DISP="Low" to IC internal voltage discharge complete	≥100	ms
T2	DISP="Low" to Source/GIP scan blank (base on Display Signal Frame Rate 60Hz)	≤50	ms
T3	IC internal voltage discharge is completed to VDD/VDDI/PVDD off	≥0	ms

Note: 1. When DISP pull "H" or "L", IC will execute the internal power on or power off procedures. Please be careful about the timing of DISP and do not interrupt it during power on or power off procedure, otherwise unexpected errors will occur.

2. RGB interface Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0].

3. LVDS interface Display signal: DCLK P/N; RX[3:0] P/N.

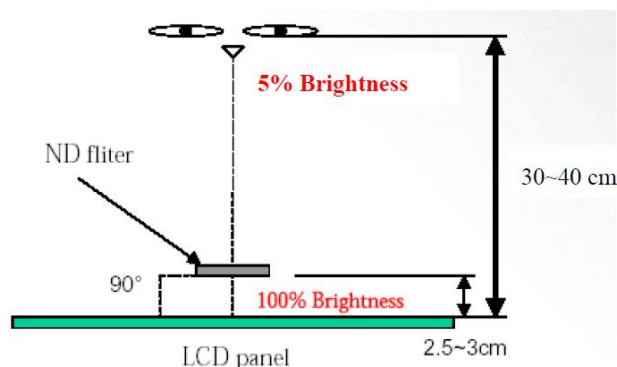
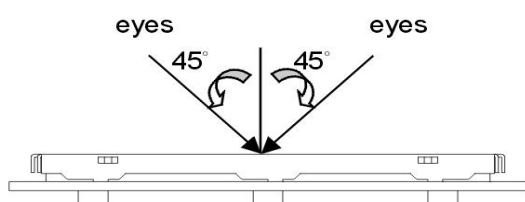


3. Inspection Specification

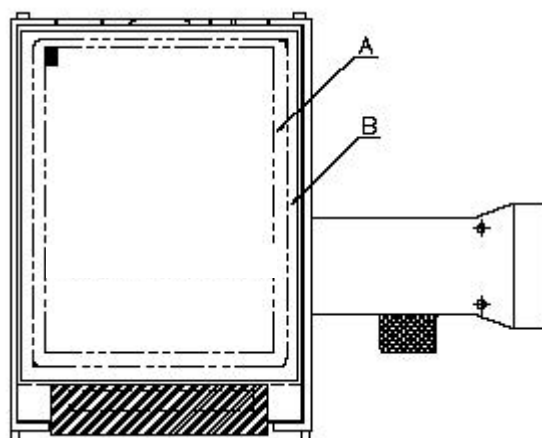
- ◆Scope : The document shall be applied to TFT-LCD Module for 0.96" ~12.3" (Ver.A01).
- ◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level II.
- ◆Equipment : Gauge 、 MIL-STD 、 SmartWin Tester 、 Sample
- ◆Defect Level : Major Defect AQL : 0.65 ; Minor Defect AQL : 1.5
- ◆OUT Going Defect Level : Sampling.
- ◆Standard of the product appearance test :

a. Manner of appearance test :

- (1). The test best be under 20W×2 fluorescent light(about 300lux ~500lux)
， and distance of view must be at 30~40 cm.
- (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area : viewing area

B area : Outside of viewing area

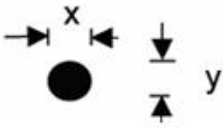
(4). Standard of inspection : (Unit : mm)



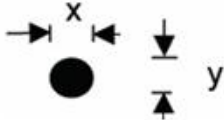
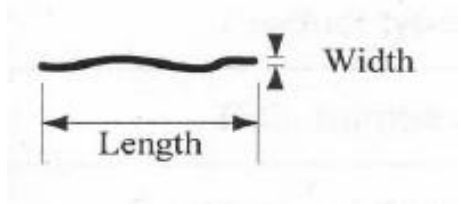
3.1 Major defect

Item No	Items to be inspected	Inspection Standard
3.1.1	All functional defects	1) No display 2) Display abnormally 3) Short circuit 4) line defect
3.1.2	Missing	Missing function component
3.1.3	Crack	Glass Crack

3.2 Minor defect

Item No	Items to be inspected	Inspection Standard	
3.2.1	Polarizer dirt and spot	For dark/white spot is defined $\varphi = (x+y) / 2$ 	
		Size φ (mm)	Acceptable Quantity
		$\varphi \leq 0.15$	Ignore
		$0.15 < \varphi \leq 0.50$	2
		$0.50 < \varphi$	0



Item No	Items to be inspected	Inspection Standard	
3.2.2	Panel dirt and spot	For dark/white spot is defined $\varphi = (x+y) / 2$ 	
		Size φ (mm)	Acceptable Quantity
		$\varphi \leq 0.10$	Ignore
		$0.10 < \varphi \leq 0.25$	3
		$0.25 < \varphi$	Not allowed
3.2.3	Line Defect Including Black line White line Scratch	Define: 	
		Width(mm) Length(mm)	Acceptable Quantity
		$W \leq 0.03$	Ignore
		$0.03 < W \leq 0.07$ $L \leq 5.0$	3
		$W > 0.07$	As round type

3.2.4	Polarizer Dent/Bubble	Size φ (mm)	Acceptable Quantity
-------	--------------------------	---------------------	---------------------



		$\phi \leq 0.15$		Ignore
		$0.15 < \phi \leq 0.50$		2
		$0.50 < \phi$		0
3.2.5	Electrical Dot Defect	Item		Acceptance (Q'ty)
		Dot Defect	Bright dot	≤ 4
			Dark dot	≤ 4
		Inspection pattern: full white, full black, Red, Green and blue screens. It is defined as dot defect if defect area $> 1/2$ dot. The distance between two dot defect ≥ 5 mm. Bright dot that can not be seen through 2% ND filter.		
3.2.6	Mura	Visible through ND5% at fullblack pattern is not allowed		



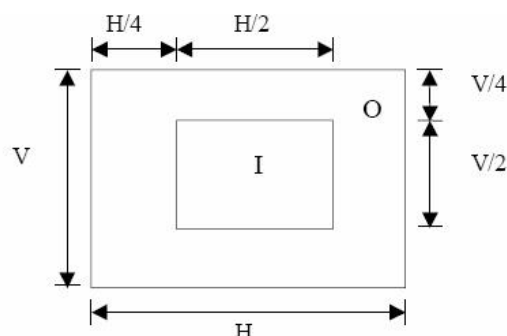
- Note:
1. Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area.
 2. The distance between two bright dot defects (red, green, blue, and white) should be larger than 5mm.
 3. The distance between black dot defects or black and bright dot defects should be more than 5mm apart.

4. The definitions of the inner display area

And outer display area

I: Inner display area

O: Outer display area



5. Polarizer bubble is defined as the bubble appears on active display area. The defect of polarizer bubble shall be ignored if the polarizer bubble appears on the outside of active display area.



4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

NO.	TEST ITEM	TEST CONDITION													
1	High Temperature Storage Test	Keep in +80 ±2℃ 240 hrs Surrounding temperature, then storage at normal condition 4hrs.													
2	Low Temperature Storage Test	Keep in -30 ±2℃ 240 hrs Surrounding temperature, then storage at normal condition 4hrs.													
3	High Temperature Operating Test	Keep in +80 ±2℃ 240 hrs Surrounding temperature, then Operating at normal condition 4hrs.													
4	Low Temperature Operating Test	Keep in -30 ±2℃ 240 hrs Surrounding temperature, then Operating at normal condition 4hrs.													
5	High Temperature / High Humidity Storage Test	Keep in +60 ℃ / 90% R.H duration for 100 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)													
6	Temperature Cycling Storage Test	<div><div><div>-30℃ (30mins)</div><div>→</div><div>+25℃ (5mins)</div><div>→</div><div>+80℃ (30mins)</div><div>→</div><div>+25℃ (5mins)</div></div><div>30 Cycle</div></div> Surrounding temperature, then storage at normal condition 4hrs.													
7	ESD Test	Air Discharge: ±8kV, 5times	Contact Discharge: ±4kV, 5times												
		Temperature ambience : 15℃ ~35℃ Humidity relative : 30% ~60% Energy Storage Capacitance(Cs+Cd) : 150pF±10% Discharge Resistance(Rd) : 330Ω±10% Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%)													
8	Vibration Test (Packaged)	Sine wave 10~55 Hz frequency (1 min/sweep) The amplitude of vibration :1.5 mm 3. Each direction (X、Y、Z) duration for 2 Hrs													
9	Drop Test (Packaged)	<table><tr><th>Packing Weight (Kg)</th><th>Drop Height (cm)</th></tr><tr><td>M < 10</td><td>100</td></tr><tr><td>10 ~ 20</td><td>80</td></tr><tr><td>20 ~ 30</td><td>70</td></tr><tr><td>30 ~ 40</td><td>60</td></tr><tr><td>40 ~ 50</td><td>50</td></tr></table> Drop Direction :※1 corner / 3 edges / 6 sides each 1time		Packing Weight (Kg)	Drop Height (cm)	M < 10	100	10 ~ 20	80	20 ~ 30	70	30 ~ 40	60	40 ~ 50	50
Packing Weight (Kg)	Drop Height (cm)														
M < 10	100														
10 ~ 20	80														
20 ~ 30	70														
30 ~ 40	60														
40 ~ 50	50														



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

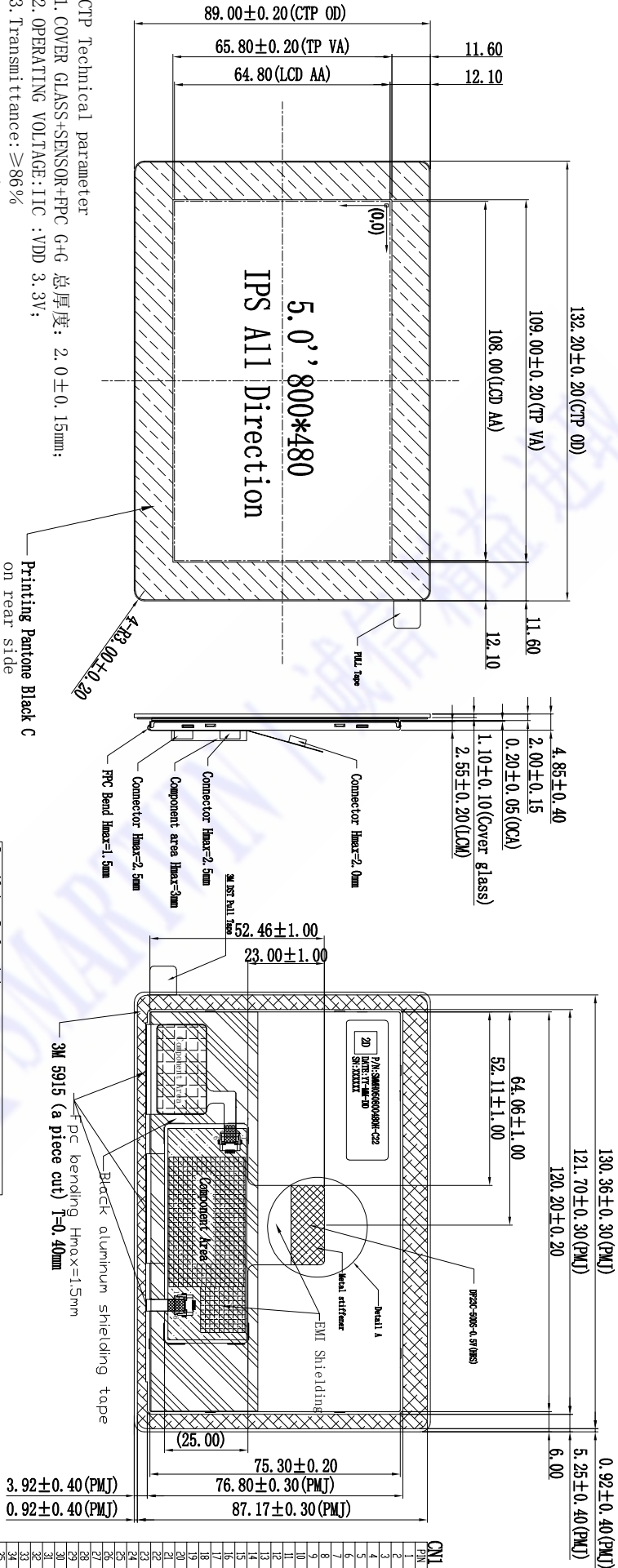
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320\pm 10^{\circ}\text{C}$ and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .
- 5.2.10 Caution!(LCM with Capacitive Touch Panel)Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).Therefore, the touch needs to be thoroughly tested inside the target application.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in nuclear power control equipment , aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



CTP Technical parameter

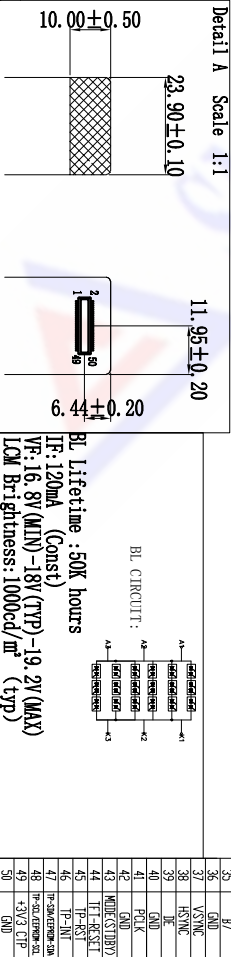
- COVER GLASS+SENSOR+FPC G+G 总厚度: 2.0±0.15mm;
- OPERATING VOLTAGE:11C :VDD 3.3V;
- Transmittance:≥86%
- Surface hardness:≥6H
- Undeclared tolerance: ±0.2
- OPERATING TEMPERATURE:-30℃~+80℃, ≤80%RH
- STORAGE TEMPERATURE:-30℃~+80℃, ≤85%RH
- ROHS
- Glass porometer: (CS)=500MPa, DOL=10um,

Note: CNI Recommended Matched connector DF23C-50DP-0.5V (HRS)

CTP	SYMBOL	BL	PN	SYMBOL
1	WJH3.3V	1	A1	
2	TP-RST	2	A2	
3	TP-INT	3	A3	
4	TP-SIM	4	K1	
5	TP-SCL	5	K2	
6	GN	6	K3	

CONFIRM ALL TYPE DRAWINGS OF THIS AND PASS BACK!

OPERATING VOLTAGE:3.3V	OPERATING CURRENT: --
DISPLAY TYPE: Normally black	VIEW DIRECTION: Free
LCD Resolution: 800 (H) RGB X 480 (V)	CTP Interface: I ² C
LCD CONTROLLER: ST72568-G6-L	CTP CONTROLLER: ST16331
BACK LIGHT: If=120mA, Vf=18V (typ)	
OPERATING TEMPERATURE: -30℃ TO 80℃ (240hrs)	STORAGE TEMPERATURE: -30℃ TO 80℃ (240hrs)
DEFAULT TOLERANCE: ±0.2	ROHS STANDARD: YES



江苏骏成电子科技有限公司
JIANGSU SMARTWIN ELECTRONICS TECHNOLOGY Co.,LTD



TITLE	模块外形图	CUSTOMER NUMBER	REV	A
DES' D BY	朱海	PRODUCT MODEL	SMARTWIN-040H-C22-WX	mm
CHK' D BY		SERIAL NUMBER	--	2024-11-21
APPROVED		SCALE	1:1	1/1